2	Incipient plasticity in	tungsten during nanoindentation: dependence on surface roughness,
3		probe radius and crystal orientation
4		Ben D. Beake ^{1*} and Saurav Goel ²
5 6 7 8 9		Villow House, Yale Business Village,Ellice Way, Wrexham, LL13 7YL, UK Fransport and Manufacturing, Cranfield University, Bedford, MK43 0AL, UK
10 11 12 13	* Corresponding	author. Email: <u>ben@micromaterials.co.uk;</u> Tel: +44 1978 261615.
14		Abstract
15	The influence of crystallo	graphic orientation, contact size and surface roughness effects on incipient
16	plasticity in tungsten wer	e investigated by nanoindentation with indenters with a range of end radius
17	(150, 350, 720 and 2800 a	nm) in single crystal samples with the (100) and (111) orientations. Results
18	for the single crystals we	re compared to those for a reference polycrystalline tungsten sample tested
19	under the same condition	s. Surface roughness measurements showed that the R_a surface roughness
20	was around 2, 4, and 6 r	im for the (100), (111) and polycrystalline samples respectively. A strong
21	size effect was observed	, with the stress for incipient plasticity increasing as the indenter radius
22	decreased. The maximum	n shear stress approached the theoretical shear strength when W(100) was
23	indented using the tip wit	h the smallest radius. The higher roughness and greater dislocation density
24	on the W(111) and polycr	systalline samples contributed to yield occurring at lower stresses.
25	Keywords: tungsten; anis	otropy; nanoindentation; incipient plasticity
26 27	Abbreviations:	
28	BCC	Body centred cubic
29	FCC	Face centred cubic
30	ISE	Indentation size effect
31	NPL	National Physical Laboratory
32	RMS	Root mean square

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34	Nomenclature:	
35	a	Contact radius
36	Al	Aluminium
37	E or E_{s}	Elastic modulus of the material
38	E_r	Reduced elastic modulus
39	h^*	Characteristic length
40	$h_{\rm c}$	Contact depth
41	h_{max}	Depth under maximum load at pop-in
42	h_r	Residual indentation depth
43	H_0	Macroscopic hardness
44	L	Applied load
45	G	Shear modulus
46	Mo	Molybdenum
47	$P_{ m m}$	Mean contact pressure
48	p_0	Maximum contact pressure
49	R	End radius of the indenter
50	R_{a}	Average surface roughness
51	Та	Tantalum
52	W	Tungsten
53	$ au_{max}$	Maximum shear stress
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58 **1. Introduction**

Tungsten (W) is a technologically important BCC metal with potential applications in the next 59 60 generation of nuclear reactors, being a favoured choice for plasma-facing components in fusion 61 reactors [1-3]. ISO:14577 specifies that W being very close to elastically isotropic (Zener anisotropy ratio is 1.01) while having a high elastic modulus makes it an important reference material for 62 indirectly calibrating nanomechanical test instruments due to its high sensitivity to the instrument 63 64 frame stiffness. It has the highest melting point of all the metals and its high temperature nanomechanical behaviour is beginning to be explored [4]. However, as yet relatively little attention 65 has been given to the influence of crystallographic orientation, loading rate and surface roughness, 66 67 and how these might influence size effects in incipient plasticity and hardness at the nano-/ and micro/-scale [5]. 68

During nanoindentation, both BCC and FCC metals can show displacement bursts that are known as "pop-ins" [6-8]. Typically in BCC metals such as W, Cr, Mo and Ta, a single yield event is observed while for close packed metals multiple pop-in ("staircase") behaviour is more common

72 [9]. It is generally accepted that with a sharp indenter, incipient plasticity at the pop-in event occurs 73 due to homologous dislocation nucleation and the shear stress required can approach the theoretical strength [10]. The presence of thick thermally grown oxide layers can modify the stress 74 75 distributions under the indenter so that a pop-in may be associated with oxide fracture [6]. However, as the native oxide on tungsten is much thinner, of the order of ~ 0.7 nm thick at room temperature 76 [11], oxide fracture is not thought to contribute to the observed behaviour [12]. Shim et al. [13] 77 78 noted that the increase in strength as the size of the contact decreases can be considered to be a 79 different type of indentation size effect to that commonly seen in hardness, since the latter depends 80 on the yielding and work-hardening behaviour of the material and the former on the stress to initiate 81 dislocation plasticity. In a fusion reactor, tungsten is subjected to intense bombardment from alpha particles and hydrogen ions which can cause indentation size effects[14]. Being able to deconvolute 82 the origins of the different indentation size effects (ISEs) on the observed behaviour is essential 83 84 since they will all contribute to the behaviour at a similar scale (e.g. within ~100 nm of the surface).

Yao et al. [1] reported a dependence on crystallographic orientation on electrochemically 85 86 polished, vacuum annealed (12h at 950 °C) and D-implanted single crystal tungsten with the critical 87 load for pop-in with a R = 675 nm indenter being much larger on (100) and (110) surfaces than on the (111) orientation. Contrarily, they found no orientation dependence for hardness. 88 89 Stelmashenkoet al. [15] reported Vickers hardness measurements showing higher hardness and 90 higher pile-up around the indentations for W(100). Pethica's group noted that after mechanical 91 polishing a number of dislocation systems are active at low load in W(100) and a clear single pop-in 92 was not observed [16]. They also reported that the hardness of mechanically polished W samples determined at depths higher than the pop-in event was higher than that of electropolished samples. 93

Most studies on incipient plasticity of pure metals have used indenters of one or at most two radii, making the effect of tip radius difficult to establish accurately. There have been two recent reports using a wide range of tip radius. Shim et al. [13] studied the influence of indenter radius (R= 0.58 to 209 microns) on pop-in occurring in the FCC metal Ni(100) and reported that the critical

98 loads and maximum shear stresses under the indenter increased as the radius decreased. Wu et al.
99 [17] investigated the onset of plasticity in the BCC metal chromium using indenters with tip radius
100 ranging from 60-759 nm and also found that the stress required for incipient plasticity increased
101 with a reduction in tip radius.

102 There has been recent interest in the influence of the surface state on the load required for pop-in [8, 9, 12, 14]. Although it is generally accepted that pop-in events require highly polished 103 104 surfaces, it is a common practice in the literature for either the surface roughness to notbe quoted or 105 for only an approximate measure of R_a to be provided. On Al(001), Shibutani et al. [8] observed that the critical load scaled inversely with surface roughness. A reduction in R_a from ~2.5 nm to under 106 107 0.5 nm resulted in the critical load increasing by a factor of 3. Bahr et al. [6] reported that, as opposed to electropolished surfaces, mechanically polished W single crystals did not show pop-ins. 108 109 Biener et al [9] reported that on Ta(001) there was no difference between electropolished or 110 mechanically polished surfaces provided a high-quality surface finish was obtained. They found a tight distribution in the critical load for pop-in for a Ta(001) surface with the RMS roughness well 111 below 1 nm. Introducing surface roughness on Ta by low-energy Ar⁺ ion bombardment suppressed 112 the linear elastic regime and the pop-in behaviour. 113

This work reports novel findings obtained from nanoindentation experiments performed on tungsten samples. The objective of this study was to investigate the contribution of size effects to incipient plasticity in tungsten using a wide range of indenter radius (0.15-2.8 microns). Alongside this, the influence of crystallographic orientation, loading rate and surface roughness were also studied on single crystals of tungsten with the (100) and (111) orientation and a reference polycrystalline tungsten sample. Nanoindentation data at a lower load were supplemented by measurements to 500 mN to determine the conventional indentation size effect in hardness.

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124 **2. Experimental**

125 2.1 Materials

Two high purity polished tungsten single crystals and a high purity polycrystalline tungsten certified 126 127 reference sample were tested. The sample with (100) orientation was provided by KRISS (Korea), originally for the VAMAS TWA22 Intercomparison on nanoindentation, being supplied by 128 Goodfellow (USA) and polished by KRISS. The sample with (111) orientation was supplied by 129 130 Goodfellow (UK) and was of thickness 2 mm and diameter 6 mm, and was polished on one side to 131 better than 1 micron (W 002166). The quoted elastic modulus and Poisson's ratio of the samples were 411 GPa and 0.28 respectively. The polycrystalline certified reference tungsten sample ("JGA-132 133 105". Instrumented Indentation Reference Block, DataSure-IIT, NPL, Teddington, UK) was obtained from NPL, based in the UK. Its elastic modulus and Poisson's ratio were determined by 134 NPL in accordance with BS EN 843-2:2006. The certified value of E obtained by NPL was 411.5 \pm 135 1.9 GPa and the Poisson's ratio was 0.2806 ± 0.0017 . The density of the polycrystalline sample was 136 1.9259 g cm⁻³. The sample was coarse-grained with an average grain size in the region of 10 μ m. 137 The tungsten samples were tested as-received and no further attempt was made to modify surface 138 roughness or near-surface defect density by further polishing or annealing steps. Surface roughness 139 was measured over a line profile using the Surface Topography option in the Scanning Module of 140 the NanoTest using (i) a spheroconical diamond probe with a nominal end radius of 5 microns (the 141 142 actual end radius was separately determined as 4 microns) (ii) a well-worn Berkovich indenter with an end radius of 1 µm. Surface roughness of the single crystal samples was also measured at the 5 143 144 μm x 5 μm scale by AFM (NanoSurf Nanite B). Table 1 summarises the surface roughness data. The AFM images revealed the presence of very fine polishing marks on the surface of the (111) 145 146 oriented W which were absent on the (100) oriented W.

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	$R_{\rm a}$ surface roughness (nm)			
	AFM (5 µm x 5	Line scan with $R = 1.0$	Line scan with $R = 4.0$	
	μm area)	µm diamond (over 10	µm diamond (over 10	
		μm length)	μm length)	
W(100)	1.4 ± 0.6	2.0 ± 0.3	2.3 ± 0.5	
W(111)	4.0 ± 0.7	3.1 ± 0.4	5.5 ± 1.6	
Polycrystalline W	Not measured	5.5 ± 1.4	6.9 ± 2.1	

150	Table 1.Surface Roughness of the measured samples
100	Tuble Tisurfuce Roughness of the meusureu sumples

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152 2.2. Nanoindentation

Nanoindentation testing of the tungsten samples was performed with a commercial nanomechanical 153 test instrument (NanoTest Platform 3, Micro Materials Ltd., Wrexham, UK) which had been 154 calibrated in accordance with the ISO 14577-4. The polycrystalline W was used to determine the 155 156 frame compliance of the instrument which was confirmed by measurements in other reference metallic samples. The end radii of the diamond indenters were calibrated by fully elastic 157 nanoindentation measurements into fused silica and sapphire reference samples. Three of the 158 159 indenters used were Berkovich indenters of different end radius and one was spheroconical diamond with a nominalend radius of 5 µm. The fused silica was a nanoindentation intercomparison 160 reference sample (obtained from KRISS, Korea) with a nominal elastic modulus of 72.5 GPa and 161 Poisson's ratio of 0.17. Its elastic properties were separately cross-checked against those of a 162 certified sample (JGC-105, NPL DataSure-IIT reference block) and were found to be consistent to 163 164 well within 0.5 %. The sapphire was a single crystal with (001) orientation (an intercomparison reference sample from the EU "Nanoindent" project supplied by Roditi, UK). The end radii were 165 166 150, 350, 720 and 2800 nm.

- 167 The loading conditions for the four indenters are summarised in Table 2.
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Table 1	Nanaindantation	tost conditions
Table 2.	Nanoindentation	test conditions

Table 2. Nanoindentation test conditions				
	Loading rate	Peak load (µN)	Hold at peak	Unloading rate
	$(\mu N/s)$		load (s)	$(\mu N/s)$
R = 150 nm	25, 100	500	3	50
R = 350 nm	25, 50, 100, 200	500	3	50
R = 720 nm	25, 100	1000	3	333
R = 2800 nm	100	3000	3	333

Adjacent indentations were made sufficiently far apart (30 μ m) to avoid influence from interaction of indentations. The mean values of the critical load, depth, mean pressure and maximum shear stress at pop-in together with their standard deviations for each of the indenters are summarised in Table 3 (a-d). The mean values shown in Table 3 were derived from 35-50 indents for each sample/loading rate/indenter combination with the three sub-micron radius indenters and from 20 indents for *R* = 2800 μ m.

	Critical load (µN)	Depth at pop-in (nm)	Mean pressure at pop-in (GPa)	Maximum shear stress at pop-in (GPa)
W(100) at 25 µN/s	153 ± 99	9.2 ± 3.8	33.7 ± 6.7	15.4 ± 3.1
W(100) at 100 µN/s	124 ± 85	7.2 ± 3.0	32.2 ± 6.6	14.4 ± 2.8
$W(111)$ at 25 μ N/s	36 ± 13	3.1 ± 0.9	24.8 ± 3.4	9.8 ± 1.1
W(111) at 100 µN/s	37 ± 13	3.4 ± 0.8	23.2 ± 2.9	9.9 ± 3.5

177 Table 3(a). Pop-in behaviour with the 150 nm end radius indenter

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179 Table 3(b). Pop-in behaviour with the 350 nm end radius indenter

	Critical load	Depth at pop-in	Mean pressure	Maximum
	(µN)	(nm)	at pop-in (GPa)	shear stress at
				pop-in (GPa)
W(100) at 25 µN/s	182 ± 91	7.8 ± 2.8	20.3 ± 3.3	9.4 ± 1.5
W(100) at 100 µN/s	173 ± 102	7.1 ± 3.0	21.1 ± 3.6	9.2 ± 1.7
W(111) at 25 µN/s	69 ± 60	4.3 ± 2.3	13.3 ± 2.6	6.7 ± 1.4
W(111) at 100 µN/s	67 ± 29	4.3 ± 1.3	16.2 ± 1.3	6.8 ± 0.7
Polycrystalline W at	74 ± 62	4.3 ± 3.0	14.7 ± 2.1	6.7 ± 1.8
25 µN/s				
Polycrystalline W at	97 ± 49	5.5 ± 2.4	18.7 ± 1.7	7.6 ± 1.3
100 µN/s				

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181 **Table 3(c).** Pop-in behaviour with the 720 nm end radius indenter

	Critical load	Depth at pop-in	Mean pressure	Maximum
	(µN)	(nm)	at pop-in (GPa)	shear stress at
				pop-in (GPa)
W(100) at 25 µN/s	226 ± 91	6.8 ± 2.0	14.3 ± 2.8	6.3 ± 1.1
W(100) at 100 µN/s	237 ± 89	6.5 ± 1.8	15.8 ± 2.2	6.4 ± 0.8
W(111) at 25 µN/s	97 ± 95	4.2 ± 3.1	8.5 ± 2.8	4.3 ± 1.6
W(111) at 100 µN/s	100 ± 51	4.2 ± 1.5	10.2 ± 1.6	4.8 ± 0.8

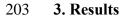
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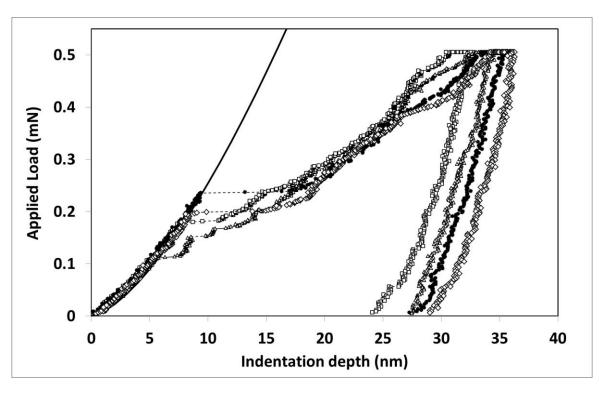
184	Table 3(d).	Pop-in	behaviour v	with the	2800 nm	end radius	indenter
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	Critical load (µN)	Depth at pop-in (nm)	Mean pressure at pop-in (GPa)	Maximum shear stress at
				pop-in (GPa)
W(100)	380 ± 134	7.3 ± 1.7	5.7 ± 0.8	3.0 ± 0.4
W(111)	250 ± 137	5.3 ± 2.0	5.0 ± 1.2	2.6 ± 0.5

Measurements were also performed with the indenter with end radius R = 350 nm over the load 185 range 10-500 mN where it has the Berkovich geometry. The loading rate was 10 mN/s, the 186 unloading rate was 20 mN/s and the hold at peak load was for 30s. Additional tests were run with a 187 188 loading time constant equal to 15 s and unloading equal to 2 s. No evidence of rate sensitivity after 189 the 30 s hold at peak load was found, which is consistent with the small indentation creep strain of 190 tungsten at room temperature reported in the past [4]. The thermal drift correction was from 40 s in 191 contact prior to loading and at 90% unloading in all the tests. The reduced indentation modulus (E_r) is related to the elastic modulus (*E*_s) of the material according to $\frac{1}{E_r} = \frac{1-v_s^2}{E_s} + \frac{1-v_i^2}{E_i}$ where *E*_i is the 192 193 elastic modulus of the diamond indenter and v_s and v_i are the Poisson's ratios of the sample and 194 indenter respectively. For tungsten, a reduced indentation modulus of 321 GPa corresponds to an 195 elastic modulus of 411 GPa. The mean contact pressure up to pop-in can be determined from Hertzian mechanics as $P_m = L/\pi a^2$ where L is the applied load and the contact radius a is given by 196 $a = \sqrt{2Rh_c - h_c^2}$ where $h_c = (h_{max} + h_r)/2$ so that h_c is the contact depth, h_{max} is the depth under load 197 at pop-in and h_r is the residual depth which is taken as zero as the contact is fully elastic to the 198 points considered. The maximum shear stress (τ_{max}) can also be determined from Hertzian 199 analysis. At pop-in, $\tau_{max} = 0.31 p_0$ where $p_0 = \sqrt[3]{\frac{6PE_r^2}{\pi^3 R^2}}$. 200

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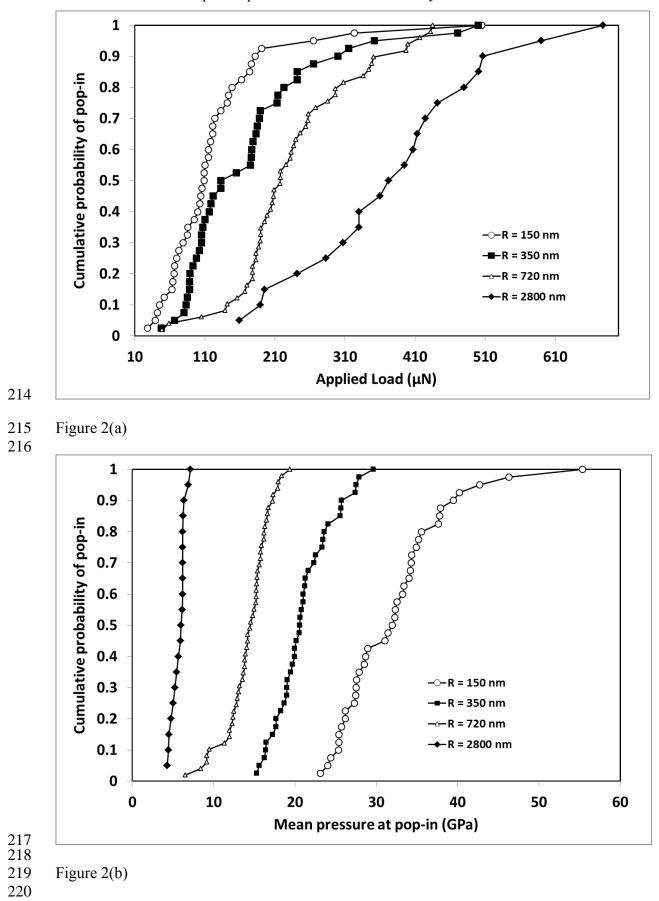


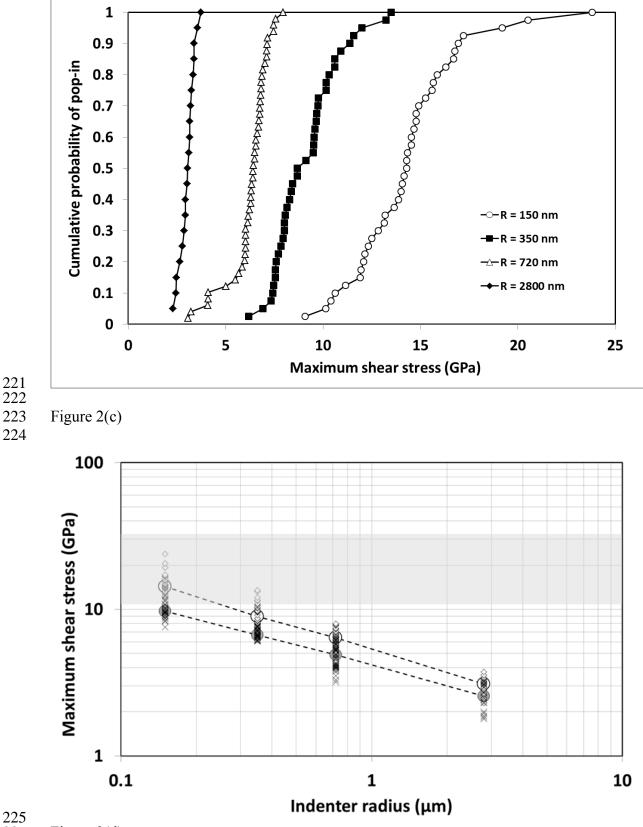


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Figure 1: Typical indentation behaviour on the W(100) with the R = 350 nm tip 207

Typical indentation behaviour on the W(100) with the R = 350 nm probe is shown in figure 1. The loading behaviour is elastic up until a pop-in occurs. If no pop-in occurred before the peak load was reached, then the contact was completely elastic and the entire loading curve could be fitted by Hertzian mechanics (the dotted line in figure 1) using the power-law relationship $P\alpha h^{1.5}$ according to $P = \frac{4}{3}E_r R^{0.5}h^{1.5}$. The pop-in data with the R = 350 nm probe at 100 µN/s are displayed as cumulative probability plots in figures 2(a) to 2(d).

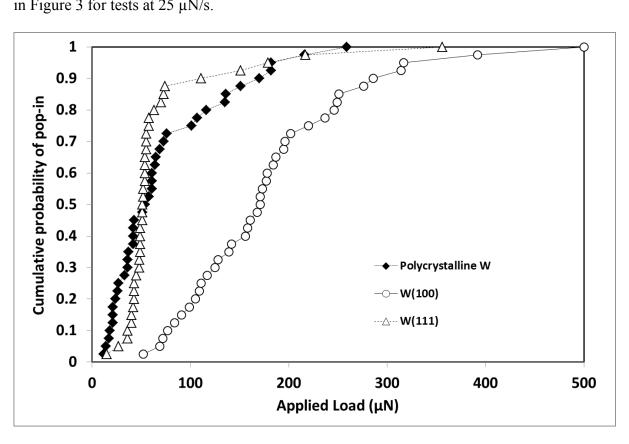




226 Figure 2(d) 227

Figure 2: Indenter radius dependence of the pop-in behaviour with loading rate = 100μ N/s (a) critical load (b) mean pressure at pop-in (c) maximum shear stress (d) variation in maximum shear stress with indenter radius for W(100) (diamonds) and W(111) (crosses). The median values at each *R* are shown by the larger circles. The shaded region covers from *G*/5 to *G*/30 where *G* is shear modulus.

233 The critical load for pop-in on W(100) varied with the indenter radius as shown in Figure 2(a). 234 From Figure 2 in conjunction with Table 3, no evidence was found that would suggest the influence 235 of loading rate on the load required for pop-in on any of the samples studied. The pop-in events were much less pronounced on the W(111) and polycrystalline tungsten samples, with the yield 236 237 event being more commonly associated with a smaller displacement burst followed by further small 238 periodic events as the load increased. The distribution of cumulative probability of pop-in for 239 W(111) in tests at 25 μ N/s or 100 μ N/s was different to that for the other two samples as illustrated 240 in Figure 3 for tests at 25 μ N/s.



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Figure 3: Cumulative probability plots of the critical load on W(100), W(111) and the polycrystalline W samples with the R = 350 nm tip at 25 μ N/s.

The sample with the (111) orientation showed a tighter distribution. After pop-in, the hardness from the unloading curve analysis was lower than the mean pressure in the contact area at pop-in. Analysis of post-yield unloading curves showed the W(111) and polycrystalline tungsten samples to have consistently higher hardness than the W(100) as summarised in Table 4 (a-d).

chu raulus muchter			
	H (GPa)	<i>E</i> _r (GPa)	h_c (nm)
W(100) at 25 µN/s	5.45 ± 0.25	322 ± 36	45.9 ± 1.4
W(100) at 100 µN/s	5.99 ± 0.35	322 ± 41	43.2 ± 1.6
$W(111)$ at 25 μ N/s	7.84 ± 0.72	345 ± 43	36.3 ± 2.2
W(111) at 100 µN/s	7.52 ± 0.55	320 ± 36	37.2 ± 1.8

Table 4(a).Hardness and elastic modulus from nanoindentation to 500 μN with the 150 nm end radius indenter

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Table 4(b).Hardness and elastic modulus from nanoindentation to 500 μN with the 350 nm end radius indenter

end radius indenter			
	H (GPa)	<i>E</i> _r (GPa)	h_c (nm)
W(100) at 25 µN/s	6.91 ± 0.34	325 ± 39	31.0 ± 1.2
W(100) at 100 µN/s	6.91 ± 0.41	321 ± 43	31.1 ± 1.4
W(111) at 25 µN/s	8.73 ± 1.1	335 ± 47	26.1 ± 2.4
W(111) at 100 µN/s	8.68 ± 0.86	323 ± 41	26.2 ± 1.9
Polycrystalline W at 25 µN/s	9.63 ± 1.1	344 ± 45	24.2 ± 2.0
Polycrystalline W at 100 µN/s	9.43 ± 0.96	338 ± 37	24.5 ± 1.9

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257Table 4(c).Hardness and elastic modulus from nanoindentation to 1000 μN with the 720 nm258end radius indenter

chu raulus muchter			
	H (GPa)	$E_{\rm r}({\rm GPa})$	h_c (nm)
W(100) at 25 µN/s	5.98 ± 0.25	326 ± 24	40.6 ± 1.4
W(100) at 100 µN/s	6.21 ± 0.27	319 ± 18	41.8 ± 1.4
$W(111)$ at 25 μ N/s	7.28 ± 0.68	324 ± 21	35.9 ± 2.6
W(111) at 100 µN/s	7.45 ± 0.55	324 ± 21	35.1 ± 2.0

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Table 4(d).Hardness and elastic modulus from nanoindentation 3000 μN with the2800 nm
 end radius indenter

	H (GPa)	<i>E</i> _r (GPa)	h_c (nm)	
W(100)	4.84 ± 0.20	297 ± 24	35.6 ± 1.5	
W(111)	5.84 ± 0.67	301 ± 39	29.8 ± 3.2	

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The elastic moduli of all three samples were very similar, with the polycrystalline sample being typically ~3 % stiffer. The measurements at higher load confirmed the expected ISE upon hardness for all three samples but not depth dependence of their elastic properties. There was a linear relationship between H^2 and 1/h over the depth range of the 10-500 mN data so they were analysed with a Nix-Gao [18] plot using the formula $\frac{H}{H_0} = \sqrt[2]{1 + \frac{h^*}{h}}$ to determine the characteristic length h^* and macroscopic hardness, H_0 , which are shown in Table 5.

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	H_0 (GPa)	<i>h</i> * (nm)
W(100)	3.87	342
W(111)	4.79	463
Polycrystalline W	5.21	278

274	Table 5.Nix-Ga	o fitting parameters
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276 **4. Discussion**

Marked crystallographic and contact size effects on the incipient plasticity of tungsten were found 277 278 in this study. Surface profilometry measurements and indentations to higher loads were used to provide relevant information regarding the surface roughness and conventional size effect upon 279 280 hardness of the samples. Across the entire load range of the instrument used (0-500 mN), the unloading curve data showed constant elastic modulus, consistent with the literature value ($E_r = 321$ 281 GPa; E = 411 GPa) with the surface roughness increasing the variability at low indentation depth. 282 283 Pile-up around the indentation due to cross-slip can increase the contact area leading to an over-284 estimate of the elastic modulus [19] with an increase of >10% reported for W(100) [20] and ionirradiated polycrystalline tungsten [21]. In the current study, a much smaller effect was found in line 285 286 with other recent results on polycrystalline tungsten [21]. The slightly lower modulus obtained from 287 the measurements with the largest radius may also be an effect of the surface roughness together with a reduction in pile-up. Walter et al. [22] reported that the modulus of CrN films with $R_a = 2-10$ 288 nm was under-estimated by 5-14 % in simulations with a spherical indenter having an end radius of 289 290 50µm.

291 All three samples showed a strong ISE upon hardness with the Nix-Gao plot revealing marked differences in their characteristic length and macroscopic hardness thereby implying a 292 293 higher dislocation density at or near the surface of the W(111) sample. The rough surface model of 294 Kim et al. [23] suggests that the characteristic length can be under-estimated in the standard Nix-295 Gao treatment unless roughness is taken into account. For the Ni surfaces, they tested and found 296 that the under-estimations were around 70 nm for surfaces with R_a = 3.2 and 8.7 nm. If similar 297 behaviour of tungsten samples used in this study is assumed, the characteristic length of the polycrystalline sample becomes very close to that of W(100), but its difference with that of W(111)298

is increased.

Significantly higher critical loads for pop-in were found for W(100) than for W(111), 300 301 consistent with previous observations by Yao et al [1]. With an indenter of R = 675 nm, Yao et al [1] 302 reported critical loads on electropolished W single-crystals of the order of 7 mN and 2.5 mN for W(100) and W(111) respectively, corresponding to median shear stresses at pop-in of around 21 and 303 304 14 GPa. On Ta, the increase in pop-in load on (100) compared to (110) and (111) has been ascribed 305 to differences in the stresses. FEA analysis showed that the high hydrostatic pressures in the 306 nanoindentation test aid nucleating defects (e.g. twins, stacking faults) [24], with more recent 307 support shown by MD simulations [25].

308 For W(100), the mean maximum shear stress determined with the R = 150 nm indenter was 309 around 15 GPa, with a maximum value of 23.8 GPa. The theoretical shear strength of crystalline 310 metals can be estimated by dividing the shear modulus by 2π , and is generally quoted to be in the 311 range of G/5 to G/15. As the shear modulus (G) of W is 161 GPa, the theoretical strength will be in the range of 10.7 to 32.2 GPa, and is 25.6 GPa at $G/2\pi$. The limits at G/5 and G/15 are shown by 312 313 the shaded region in Figure 2(d). The data from use of the sharper indenters is consistent with the 314 pop-in occurring when the τ_{max} under the indenter approaches the theoretical strength, as has been 315 reported in previous studies on BCC[9], FCC metals [7] and BCC high-entropy alloys [10]. As shown in Figure 2(d), values of τ_{max} were lower for the (111) orientation of W. Hertzian contact 316 317 mechanics assumes an ideally flat surface which is however not a practical reality. Although all the 318 tungsten samples were highly polished. Table 1 shows there were differences in surface roughness with the W(111) and polycrystalline W being rougher than the W(100). With an increase in surface 319 320 roughness, the pressure on the surface of the asperities will be higher than that predicted by the 321 Hertzian treatment (which assumes an initially flat surface) so that although the apparent pressure at 322 pop-in is lower for rougher surfaces the real pressure may be significantly higher, as has been 323 shown in MD simulations of thin copper coatings [26].

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In tests on annealed and electropolished tungsten with spherical diamonds with end radii of

325 1 and 13.5 µm, Pathak et al. [12, 14] observed higher stresses at pop-in with the sharper probe. Data 326 with the blunter probe was more stochastic in nature. Notwithstanding the fact that they tested an 327 electropolished surface, their data was in quite good agreement with the results for W(100) shown 328 in Figure 2 (b). Shim et al [13] provided a qualitative explanation for the radius dependence they found in Ni(100) based on the average dislocation spacing and the stresses required to activate 329 330 existing dislocations (low stress) or to nucleate new ones in dislocation-free regions (higher stress). 331 Changing the indenter size changed the size of the highly stressed zone (which has been estimated 332 as $\sim 2.4a$ by Pathak et al. [12, 14]) relative to the average dislocation spacing. If the radius of the 333 indenter tip is much smaller than the spacing needed between dislocations for plasticity to occur, 334 then the applied stress needs to be sufficiently large to nucleate a dislocation. With larger tip radii, 335 the size of the indenter is much larger than the spacing between the dislocation and the stress required to move pre-existing dislocations is lower. Wu et al. [17] recently developed a combined 336 statistical model for the radius dependence providing further evidence that incipient plasticity could 337 be triggered either by homogeneous nucleation of dislocations when a sharp indenter is used or by 338 339 the activation of existing dislocations when indenting with tips with larger end radii. The strength drops more rapidly with increasing R due to the increasing possibility of encountering pre-existing 340 defects. The model does not consider surface roughness and it seems likely that this will also 341 342 contribute to the observed size effect. Knap and Ortiz used multiscale simulations to investigate tipradius effects during nanoindentation of Au(001) with 7 and 70 nm indenters [27]. In their 343 simulations, they found that the dislocation activity occurred before any deviation in the force curve 344 was observed. If a similar trend is also found for BCC metals and continues to larger indenter sizes, 345 then the maximum shear stress-radius dependence would be even larger than has been reported in 346 347 experimental studies to date.

348 In the experiments on tungsten performed in this work, there was no discernible rate 349 dependence over 25-200 μ N/s in either the stochastics of the pop-ins or the mean load value. 350 Although stress-based thermally activated dislocation nucleation is expected to result in the onset of

351 plasticity increasing with loading rate [28], the effect is slight in BCC metals compared to FCC 352 metals [9]. Biener et al. [9] reported a very small rate dependence on Ta(001) with RMS roughness 353 well under 1 nm, with the median value of the critical load for pop-in increasing by around 12% 354 over a x100 increase in loading rate from 50 μ N/s to 5000 μ N/s. The absence of rate dependence in this particular study over a much smaller load range appears to be due to a combination of the 355 intrinsic minimal rate sensitivity of tungsten (where creep strain during the 30 s hold period at peak 356 357 load in the higher load indentation tests is less than 0.015) and the higher surface roughness 358 (presumably local differences in roughness) of the samples.

359 Surface preparation is important as it influences the dislocation density and roughness of the 360 final surface [29]. Pathak et al. [12, 14] noted that rough mechanical polishing generally leaves a disturbed surface layer with higher dislocation content which can be removed by electropolishing. 361 On another BCC metal, Mo(001), Wang et al. [30] reported that the highest pop-in critical load was 362 observed after electropolishing. Smaller loads were found after colloidal silica polishing, and 363 polishing by alumina produced defects sufficient to fully suppress pop-in. In a study on a FCC 364 365 metal, Al (111) by Minor et al. [7], the loading data was fitted to a plot of a Hertzian elastic response. Although surface roughness was not mentioned, the presence of roughness could be 366 367 inferred by deviation of the experimental data from the elastic fitting by up to ~ 1 nm. Shibutani et 368 al. [8] studied the influence of surface roughness on the pop-ins observed when indenting Al(001) 369 with a tip of ~50 nm end radius, finding much lower critical loads for less highly polished surfaces. In interfacial force microscopy on a passivated gold surface the critical load for pop-in was reported 370 to be 30-45 % lower near a step than in defect-free regions [31]. In a molecular dynamics study of 371 the influence of surface roughness on nanoindentation, it was reported that defects typically initiate 372 373 at the side of an asperity [26, 32].

The pop-in events were much less pronounced for the W(111) and polycrystalline tungsten samples, with the yield event being more commonly associated with a smaller displacement burst followed by further small periodic events as the load increased. In addition to the roughness effect

377 described above, this appears to be partially due to higher dislocation density in these samples 378 causing an increase in the hardness. Studies have also shown that higher pre-existing dislocation 379 density lowers the critical load for pop-in. In high-purity aluminium, a reduction in probability of 380 pop-in was observed when dislocation density increased [33]. In MgO indented with a 9.5 µm tip, Montagne et al. [29] noted the contact was elastic up to a load of 300 mN when there were no pre-381 existing dislocations but reduced nearly to zero for a pre-existing density of 1.2×10^7 cm⁻². There 382 383 are differences in the distributions of cumulative probability of the critical load for pop-in between 384 the samples (Figure 3). The extent of dispersion in the first critical load on the FCC Al has been 385 reported to widen with a reduction in roughness [8]. Figure 3 shows that similar behaviour can be 386 seen in W(111). While the average surface roughness is higher on the polycrystalline sample, there 387 are smoother regions so that when indentations are made into these regions the data can more 388 closely approach that obtained from the W(100), but if measurements are made in rougher regions the corresponding critical load is much lower. Yao et al. [1] reported a reduction in critical load for 389 pop-in on W after D-implantation and Biener et al [9] reported a complete suppression on Ta(001) 390 391 after ion energy ion bombardment. In studies such as these, it is not yet clear how much of the reduction in pop-in is due to surface roughening and how much is due to higher pre-existing 392 dislocations in the near-surface layers of the tungsten. While they are to some extent interlinked, 393 394 further work on ion-irradiated samples may help to more fully deconvolute these effects.

395

396 **5.Conclusions**

397 The results being reported in this work confirm the statistical nature of incipient plasticity in the 398 nanoindentation response of tungsten over a wide range of conditions. Indenter radius (and 399 therefore contact size), surface roughness and crystallographic orientation were varied during the 400 experiments. The conclusions can be summarised as follows:

401
 A strong size effect was observed, with the stress for incipient plasticity increasing as the
 402 indenter radius was decreased. The maximum shear stress approached the theoretical shear

- 403 strength when W(100) was indented with the tip with smallest radius, whereas the (111) 404 orientation showed pop-ins at lower stress levels, which has been attributed to surface 405 roughness and greater dislocation density on the W(111) sample
- Surface preparation plays an important role in the statistical nature of pop-in during loading
 in nanoindentation tests. While they are to some extent interlinked, it was not clear whether
 the roughening of the surface itself or the defect generation in the near surface layers caused
- 409 by it has the greater effect in reducing the load at which pop-in occurs.

410

411 Acknowledgments:

412 Jan Tomastik (Joint Laboratory of Optics, Palacky University and Institute of Physics, Academy of

413 Sciences of the Czech Republic, Olomouc, Czech Republic) is thanked for his assistance with the

414 Nix-Gao analysis of the higher load indentations. SG would like to acknowledge the financial

415 support from the COST Action CA15102 funded by H2020.

416

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